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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/431,593	11/01/1999	YOSHINORI UEDA	2271/60617	8935	
75	90 10/02/2002				
IVAN S KAVRUKOV			EXAMINER		
• • • • • • • • • • • • • • • • • • • •	OF THE AMERICAS		WARREN, MATTHEY		
NEW YORK, N	Y 10036		ART UNIT	PAPER NUMBER	
			2815		
			DATE MAILED: 10/02/2002	DATE MAILED: 10/02/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)			
Office Action Summary		09/431,593	UEDA, YOSHINORI			
		Examiner	Art Unit			
		Matthew E. Warren	2815			
Period fo	The MAILING DATE of this communication app or Reply	ears on the cover sheet with the c	orrespondence address			
A SHO THE N - Exter after - If the - If NO - Failur - Any r	ORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. Insions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period we to reply within the set or extended period for reply will, by statute, eply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	ely filed s will be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).			
1)	Responsive to communication(s) filed on 27 A	<u> August 2002</u> .				
2a) <u></u>	This action is FINAL . 2b)⊠ Thi	is action is non-final.				
Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
·	on of Claims					
, —	Claim(s) 1-8 is/are pending in the application.					
	4a) Of the above claim(s) <u>9</u> is/are withdrawn from consideration.					
·						
•	6)⊠ Claim(s) <u>1-8</u> is/are rejected.					
•	Claim(s) is/are objected to.					
• —	Claim(s) are subject to restriction and/or on Papers	r election requirement.				
<i>′</i> —	The specification is objected to by the Examine					
10) 🔲 🗀	The drawing(s) filed on is/are: a)☐ accep	ted or b)⊡ objected to by the Exar	miner.			
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11)☐ The proposed drawing correction filed on is: a)☐ approved b)☐ disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12)☐ The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
	1. Certified copies of the priority documents have been received.					
	2. Certified copies of the priority documents have been received in Application No					
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
 a) The translation of the foreign language provisional application has been received. 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 						
Attachment(s)						
2) Notic	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal F	(PTO-413) Paper No(s) Patent Application (PTO-152)			
		<u> </u>				

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DETAILED ACTION

This Office Action is in response to the CPA Request filed on August 27, 2002.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States
- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

Claims 1-3, 5, 7, and 8 are rejected under 35 U.S.C. 102(b) as being anticipated by Groover, III et al. (US 4,804,636).

Groover, III et al. shows (fig. 9a – 9e) a semiconductor device comprising a Si substrate and a resistance pattern (moat) formed on the substrate. The pattern comprises a first resistance pattern (poly-si) on the substrate at a first level and a second resistance pattern (source/drain or moat) provided adjacent the first resistance

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pattern at a second level (in the substrate) lower than the first level. The second resistance pattern is connected in series to the first resistance pattern through a TiN local interconnect and has an edge defined by the first resistance pattern (moat is doped by a self aligning process-col. 20, lines 55-56). The resistance pattern comprises an interlayer insulation pattern (gate oxide) under the first resistance pattern and the second resistance pattern is lower than the insulating layer. The first resistance pattern includes a polysilicon pattern and a polycide region (TiSi₂). The device further comprises a MOS transistor having a polysilicon gate that is identical in composition to the polysilicon pattern. The second resistance pattern is formed in the substrate in the form of a salicide region (TiSi₂) defined by the first resistance pattern (moat is doped by a self aligning process-col. 20, lines 55-56).

Claims 1-3, 5-8 are rejected under 35 U.S.C. 102(e) as being anticipated by Naem (US 5,911,114).

Naem discloses (fig. 1E and col. 2, line 50 – col. 3, line 12) a semiconductor device comprising a Si substrate and a resistance pattern formed on the substrate. The pattern comprises a first resistance pattern (on Field OXide region) on the substrate at a first level and a second resistance pattern (source/drain) provided adjacent the first resistance pattern at a second level (in the substrate) lower than the first level. The second resistance pattern is electrically connected in series to the first resistance pattern through a TiN local interconnect to form the resistance element and has an edge defined by the first resistance pattern (edge of FOX region). The resistance pattern

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comprises an interlayer insulation pattern (gate dielectric) under the first resistance pattern and the second resistance pattern is lower than the insulating layer. The first resistance pattern includes a polysilicon pattern and a polycide region. The device further comprises a MOS transistor having a polysilicon gate that is identical in composition to the polysilicon pattern. The second resistance pattern is formed in the substrate in the form of a salicide region defined by the first resistance pattern. The substrate includes an impurity element with a concentration level such that a parasitic MOS transistor is formed of the first resistance pattern acting as a gate electrode and a pair of second resistance patterns at both lateral sides of the first pattern and acting as source drain regions (the device is a MOS transistor col. 2, lines 50-56). Because the device is a MOS transistor, the threshold voltage is large than a supply voltage used in the device. The pattern includes a second polysilicon pattern and polycide (14) and having an impurity concentration level larger than the concentration of the first pattern due to the doping provided by the polycide process (col. 3, lines 1-7).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Naem (US 5,911,114).

Naem shows all of the elements of the claims except the first resistance pattern and the second resistance pattern having identical resistance. However, it would have been obvious to one of ordinary skill in the art at the time the invention was made to provide a first and second resistance pattern having identical resistance values, since it has been held that discovering an optimum value of a result effective variable involves only routine skill in the art. In re Boesch, 617 F.2d 272, 205 USPQ 215 (CCPA 1980). Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to provide first and second resistance patterns having identical resistance values to form a device having a desired total resistance.

Response to Arguments

Applicant's arguments filed in the After Final Amendment of June 24, 2002 have been fully considered but they are not persuasive. The applicant primarily argues that the references of Groover III and Naem do not show all of the elements of the claims, specifically the lower resistance patterns having a first resistance pattern provided on the substrate at a first level and a second resistance pattern provided adjacent to the first one at a second level. The examiner maintains the previous rejection because the cited art discloses such configurations. Take for instance, Groover III in figures 4 discloses an upper resistance pattern which is gate electrode N1 and a lower resistance pattern (S/D 204). In the broadest sense of the term resistance pattern, any material in

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known in the art of semiconductors provides resistance and this is a resistance pattern. When taken in this view, the gate of Groover including the sidewall insulation and gate dielectric is an upper resistance pattern and the source/drain regions including the silicide layer is a lower resistance pattern. It can also be seen that the edge of the upper resistance patter defines the lower resistance pattern. A similar configuration is seen in the figures of Naem. For these reasons, the cited art shows the resistance patterns having the claimed configuration.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Matthew E. Warren whose telephone number is (703) 305-0760. The examiner can normally be reached on Mon-Thurs, and alternating Fri, 9:00-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on (703) 308-1690. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 305-3432 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

MEW 70EW October 1, 2002

EDDIE LEE

SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800